

IRF520 IRF520FI

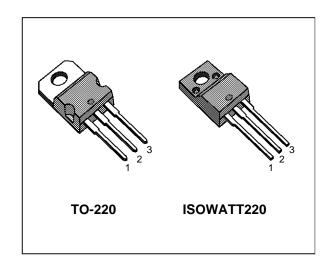
N - CHANNEL ENHANCEMENT MODE POWER MOS TRANSISTORS

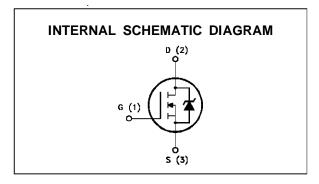
| TYPE | V _{DSS} R _{DS(on)} | | Ι _D |
|----------|--------------------------------------|----------|----------------|
| IRF520 | 100 V | < 0.27 Ω | 10 A |
| IRF520FI | 100 V | < 0.27 Ω | 7 A |

- TYPICAL $R_{DS(on)} = 0.23 \Omega$
- AVALANCHE RUGGED TECHNOLOGY
- 100% AVALANCHE TESTED
- REPETITIVE AVALANCHE DATA AT 100°C
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY
- 175°C OPERATING TEMPERATURE

APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- SOLENOID AND RELAY DRIVERS
- REGULATORS
- DC-DC & DC-AC CONVERTERS
- MOTOR CONTROL, AUDIO AMPLIFIERS
- AUTOMOTIVE ENVIRONMENT (INJECTION, ABS, AIR-BAG, LAMPDRIVERS, Etc.)





ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Parameter Value | | Unit |
|---------------------|---|-----------------|----------|------|
| | | IRF520 | IRF520FI | |
| V _{DS} | Drain-source Voltage (V _{GS} = 0) | 1(| 00 | V |
| V_{DGR} | Drain- gate Voltage ($R_{GS} = 20 \text{ k}\Omega$) | 1(| 00 | V |
| V _G s | Gate-source Voltage | ± : | 20 | V |
| I _D | Drain Current (cont.) at T _c = 25 °C | 10 | 7 | А |
| I _D | Drain Current (cont.) at T _c = 100 °C | 7 5 | | А |
| I _{DM} (•) | Drain Current (pulsed) | 40 | 40 | А |
| P _{tot} | Total Dissipation at T _c = 25 °C | 70 | 35 | W |
| | Derating Factor | 0.47 | 0.23 | W/°C |
| V _{ISO} | Insulation Withstand Voltage (DC) | | | V |
| T _{stg} | Storage Temperature | -65 to 175 | | °C |
| Tj | Max. Operating Junction Temperature | 175 | | °C |

(•) Pulse width limited by safe operating area

June 1993 1/9

THERMAL DATA

| | | | TO-220 | ISOWATT220 | |
|--|--|----------------------|--------------------|------------|--------------------|
| R _{thj-case} | Thermal Resistance Junction-case | Max | 2.14 | 4.29 | °C/W |
| R _{thj-amb} R _{thc-s} T _I | Thermal Resistance Junction-ambient Thermal Resistance Case-sink Maximum Lead Temperature For Soldering Pu | Max Typ irpose | 62.5 0.5 300 | | °C/W °C/W °C |

AVALANCHE CHARACTERISTICS

| Symbol | Parameter | Max Value | Unit |
|-----------------|---|-----------|------|
| I _{AR} | Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T_j max, $\delta < 1\%$) | 10 | А |
| Eas | Single Pulse Avalanche Energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 25$ V) | 36 | mJ |
| E _{AR} | Repetitive Avalanche Energy (pulse width limited by T_j max, δ < 1%) | 9 | mJ |
| I _{AR} | Avalanche Current, Repetitive or Not-Repetitive $(T_c = 100 ^{\circ}\text{C}, \text{ pulse width limited by } T_j \text{max}, \delta < 1\%)$ | 7 | А |

ELECTRICAL CHARACTERISTICS ($T_{case} = 25$ ^{o}C unless otherwise specified) OFF

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|----------------------|--|---|------|------|-------------|----------|
| V _{(BR)DSS} | Drain-source Breakdown Voltage | $I_D = 250 \mu\text{A}$ $V_{GS} = 0$ | 100 | | | \ |
| I _{DSS} | Zero Gate Voltage Drain Current (V _{GS} = 0) | $V_{DS} = Max Rating$ $V_{DS} = Max Rating x 0.8 T_c = 125 °C$ | | | 250 1000 | μA μA |
| IGSS | Gate-body Leakage Current (V _{DS} = 0) | V _{GS} = ± 20 V | | | ± 100 | nA |

ON (*)

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|---------------------|-----------------------------------|--|------|------|------|------|
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS}$ $I_D = 250 \mu A$ | 2 | 2.9 | 4 | V |
| R _{DS(on)} | Static Drain-source On Resistance | $V_{GS} = 10V$ $I_D = 5$ A | | 0.23 | 0.27 | Ω |
| I _{D(on)} | On State Drain Current | $V_{DS} > I_{D(on)} \times R_{DS(on)max} V_{GS} = 10 \text{ V}$ | 10 | | | Α |

DYNAMIC

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|--|---|---|------|-----------------|------------------|----------------|
| g _{fs} (*) | Forward Transconductance | $V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $I_D = 5 A$ | 2.7 | 4.5 | | S |
| C _{iss} C _{oss} C _{rss} | Input Capacitance Output Capacitance Reverse Transfer Capacitance | V _{DS} = 25 V f = 1 MHz V _{GS} = 0 | | 330 90 25 | 450 120 40 | pF pF pF |



ELECTRICAL CHARACTERISTICS (continued)

SWITCHING RESISTIVE LOAD

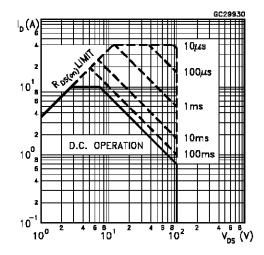
| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|--|---|--|------|----------------------|----------------------|----------------------|
| $t_{ m d(on)} \ t_{ m r} \ t_{ m d(off)} \ t_{ m f}$ | Turn-on Time Rise Time Turn-off Delay Time Fall Time | $V_{DD} = 50 \text{ V}$ $I_D = 5 \text{ A}$ $R_{GS} = 4.7 \Omega$ $V_{GS} = 10 \text{ V}$ (see test circuit) | | 10 50 25 20 | 15 75 40 30 | ns ns ns ns |
| $egin{array}{c} Q_{g} \ Q_{gs} \ Q_{gd} \end{array}$ | Total Gate Charge Gate-Source Charge Gate-Drain Charge | $I_D = 10 \text{ A}$ $V_{GS} = 10 \text{ V}$ $V_{DD} = \text{Max Rating x 0.8}$ (see test circuit) | | 15 7 4 | 25 | nC nC nC |

SOURCE DRAIN DIODE

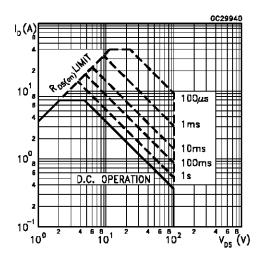
| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|---|--|-------------------------------------|------|------|----------|------|
| I _{SD} I _{SDM} (•) | Source-drain Current Source-drain Current (pulsed) | | | | 10 40 | A A |
| V _{SD} (*) | Forward On Voltage | $I_{SD} = 10 \text{ A} V_{GS} = 0$ | | | 1.6 | V |
| t _{rr} | Reverse Recovery Time | $I_{SD} = 10 \text{ A}$ | | 80 | | ns |
| Q _{rr} | Reverse Recovery Charge | , | | 0.22 | | μC |

^(*) Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %

Safe Operating Area for TO-220



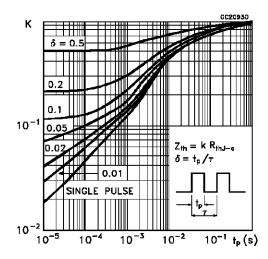
Safe Operating Area for ISOWATT220



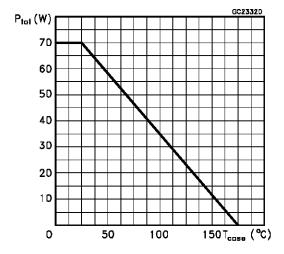


^(•) Pulse width limited by safe operating area

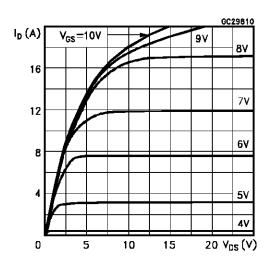
Thermal Impedance for TO-220



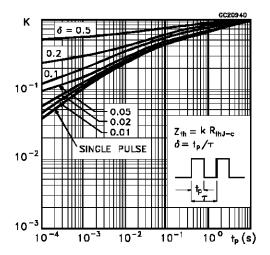
Derating Curve for TO-220



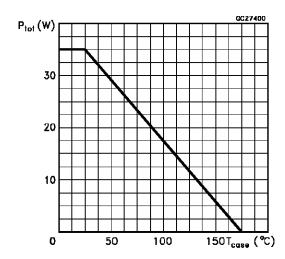
Output Characteristics



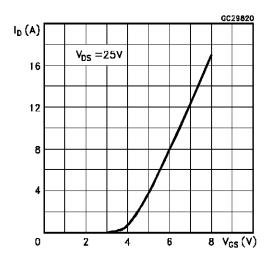
Thermal Impedance for ISOWATT220



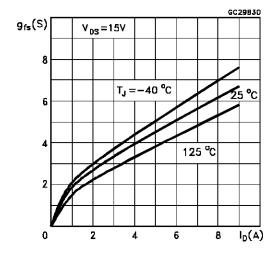
Derating Curve for ISOWATT220



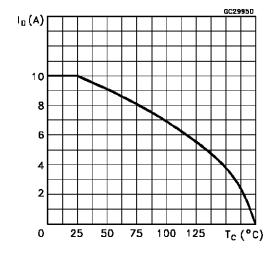
Transfer Characteristics



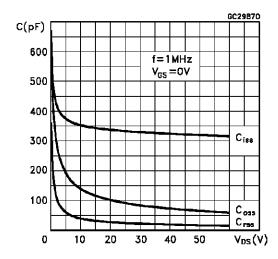
Transconductance



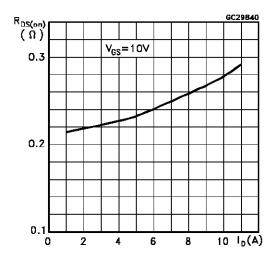
Maximum Drain Current vs Temperature



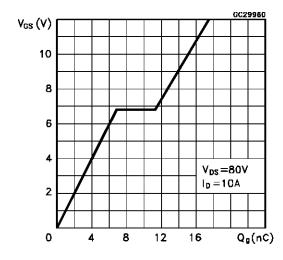
Capacitance Variations



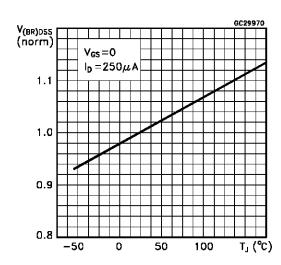
Static Drain-source On Resistance



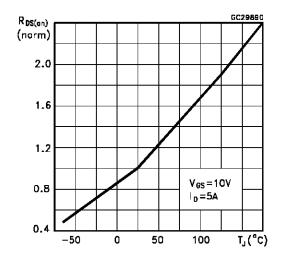
Gate Charge vs Gate-source Voltage



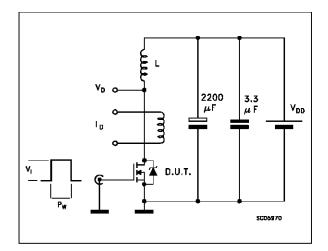
Normalized Breakdown Voltage vs Temperature



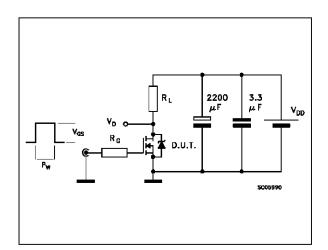
Normalized On Resistance vs Temperature



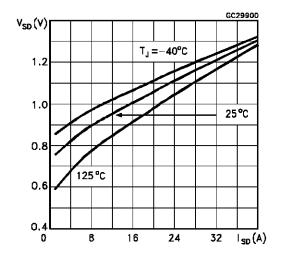
Unclamped Inductive Load Test Circuit



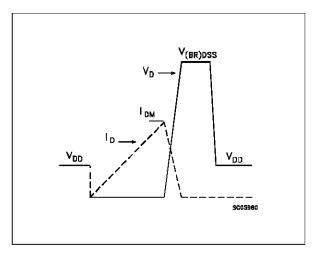
Switching Time Test Circuit



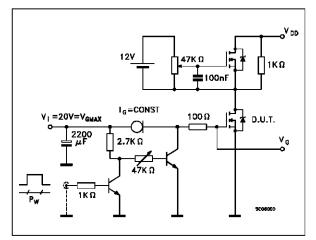
Source-drain Diode Forward Characteristics



Unclamped Inductive Waveforms

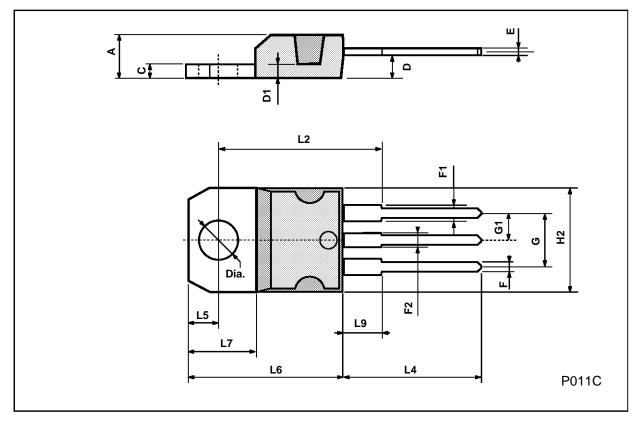


Gate Charge Test Circuit



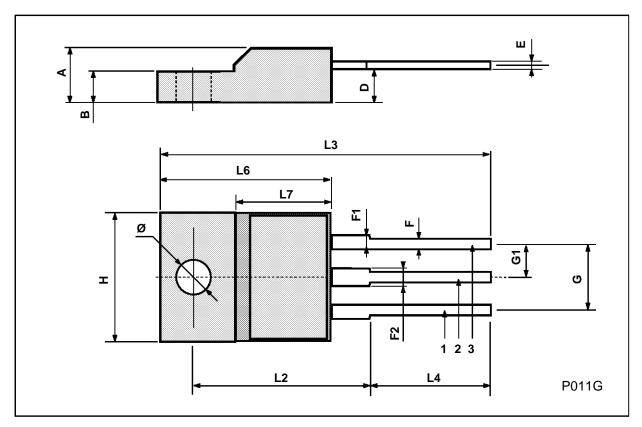
TO-220 MECHANICAL DATA

| DIM. | | mm | | | inch | |
|--------|-------|------|-------|-------|-------|-------|
| DIIVI. | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| Α | 4.40 | | 4.60 | 0.173 | | 0.181 |
| С | 1.23 | | 1.32 | 0.048 | | 0.051 |
| D | 2.40 | | 2.72 | 0.094 | | 0.107 |
| D1 | | 1.27 | | | 0.050 | |
| E | 0.49 | | 0.70 | 0.019 | | 0.027 |
| F | 0.61 | | 0.88 | 0.024 | | 0.034 |
| F1 | 1.14 | | 1.70 | 0.044 | | 0.067 |
| F2 | 1.14 | | 1.70 | 0.044 | | 0.067 |
| G | 4.95 | | 5.15 | 0.194 | | 0.203 |
| G1 | 2.4 | | 2.7 | 0.094 | | 0.106 |
| H2 | 10.0 | | 10.40 | 0.393 | | 0.409 |
| L2 | | 16.4 | | | 0.645 | |
| L4 | 13.0 | | 14.0 | 0.511 | | 0.551 |
| L5 | 2.65 | | 2.95 | 0.104 | | 0.116 |
| L6 | 15.25 | | 15.75 | 0.600 | | 0.620 |
| L7 | 6.2 | | 6.6 | 0.244 | | 0.260 |
| L9 | 3.5 | | 3.93 | 0.137 | | 0.154 |
| DIA. | 3.75 | | 3.85 | 0.147 | | 0.151 |



ISOWATT220 MECHANICAL DATA

| DIM. | | mm | | | inch | |
|--------|------|------|------|-------|-------|-------|
| DIIVI. | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| А | 4.4 | | 4.6 | 0.173 | | 0.181 |
| В | 2.5 | | 2.7 | 0.098 | | 0.106 |
| D | 2.5 | | 2.75 | 0.098 | | 0.108 |
| Е | 0.4 | | 0.7 | 0.015 | | 0.027 |
| F | 0.75 | | 1 | 0.030 | | 0.039 |
| F1 | 1.15 | | 1.7 | 0.045 | | 0.067 |
| F2 | 1.15 | | 1.7 | 0.045 | | 0.067 |
| G | 4.95 | | 5.2 | 0.195 | | 0.204 |
| G1 | 2.4 | | 2.7 | 0.094 | | 0.106 |
| Н | 10 | | 10.4 | 0.393 | | 0.409 |
| L2 | | 16 | | | 0.630 | |
| L3 | 28.6 | | 30.6 | 1.126 | | 1.204 |
| L4 | 9.8 | | 10.6 | 0.385 | | 0.417 |
| L6 | 15.9 | | 16.4 | 0.626 | | 0.645 |
| L7 | 9 | | 9.3 | 0.354 | | 0.366 |
| Ø | 3 | | 3.2 | 0.118 | | 0.126 |



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